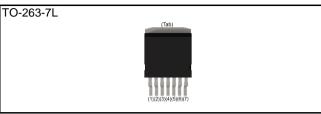


SCT4045DW7 N-channel SiC power MOSFET

V _{DSS}	750V
R _{DS(on)} (Typ.)	45mΩ
I_{D}^{*1}	31A
P _D	93W

Outline



Inner circuit

(1) Oriver Source (1) Oriver Source (2) Oriver Source (3)~(7) Power Source (1) Oriver S

Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

Packaging specifications

	Packing	Embossed tape
Туре	Reel size (mm)	330
	Tape width (mm)	24
	Basic ordering unit (pcs)	1000
	Taping code	TL
	Marking	SCT4045DW7

•Absolute maximum ratings (T_{vj} = 25°C unless otherwise specified.)

$\begin{array}{ c c c c c c } \hline Parameter & Symbol & Value \\ \hline Drain - source voltage & V_{DSS} & 750 \\ \hline Continuous drain and source current & V_{GS} = V_{GS_on} & \hline T_c = 25^{\circ}C & I_{D, I_S}^{*1} & \hline 31 & 22 & 100^{\circ}C & 10^{\circ}C & 10^$	
Continuous drain and source current $V_{GS} = V_{GS_on}$ $T_c = 25^{\circ}C$ $T_c = 100^{\circ}C$ I_D, I_S^{*1} 31Pulsed drain current $V_{GS} = V_{GS_on}$ $T_c = 25^{\circ}C$ $I_{D,pulse}^{*2}$ 61Body diode pulsed forward current $T_c = 25^{\circ}C$ $I_{S,pulse}^{*1,*3}$ 31Body diode surge forward current $V_{GS} = 0$ $V_{GS} = 0$ $I_{S,pulse}^{*1,*4}$ 61Gate - source voltage (DC) V_{GSS_DC} -4 to +21 -4 to +21Gate - source surge voltage ($t_{surge} < 300$ ns) $V_{GSS_surge}^{*5}$ -4 to +23	Unit
Continuous drain and source current $V_{GS} = V_{GS_on}$ $T_c = 100^{\circ}C$ I_D, I_S^{*1} 22Pulsed drain current $V_{GS} = V_{GS_on}$ $T_c = 25^{\circ}C$ $I_{D,pulse}^{*2}$ 61Body diode pulsed forward current $T_c = 25^{\circ}C$ $I_{S,pulse}^{*1,*3}$ 31Body diode surge forward current $V_{GS} = 0$ V $I_{S,pulse}^{*1,*4}$ 61Gate - source voltage (DC) V_{GSS_DC} -4 to +21Gate - source surge voltage ($t_{surge} < 300$ ns) $V_{GSS_surge}^{*5}$ -4 to +23	V
und source current $V_{cs} = V_{GS_on}$ $T_c = 25^{\circ}C$ $I_{D,pulse}^{*2}$ 61Body diode pulsed forward current $T_c = 25^{\circ}C$ $I_{S,pulse}^{*1,*3}$ 31Body diode surge forward current $V_{GS} = 0$ $I_{S,pulse}^{*1,*4}$ 61Gate - source voltage (DC) V_{GSS_DC} -4 to +21Gate - source surge voltage ($t_{surge} < 300$ ns) $V_{GSS_surge}^{*5}$ -4 to +23	А
Pulsed drain current $V_{GS} = V_{GS_on}$ $I_c = 25^{\circ}C$ $I_{D,pulse}$ 61Body diode pulsed forward current $T_c = 25^{\circ}C$ $I_{S,pulse}^{*1,*3}$ 31Body diode surge forward current $V_{GS} = 0$ $I_{S,pulse}^{*1,*4}$ 61Gate - source voltage (DC) V_{GSS_DC} -4 to +21Gate - source surge voltage ($t_{surge} < 300$ ns) $V_{GSS_surge}^{*5}$ -4 to +23	А
Body diode pulsed forward current $T_c = 25^{\circ}C$ $I_{S,pulse}$ 31° Body diode surge forward current $V_{GS} = 0 \text{ V}$ $I_{S,pulse}^{*1,*4}$ 61Gate - source voltage (DC) V_{GSS_DC} $-4 \text{ to } +21$ Gate - source surge voltage ($t_{surge} < 300 \text{ ns}$) $V_{GSS_surge}^{*5}$ $-4 \text{ to } +23$	А
Body alode ourge forward ourientImage: Second StructureGate - source voltage (DC) V_{GSS_DC} -4 to +21Gate - source surge voltage ($t_{surge} < 300$ ns) $V_{GSS_surge}^{*5}$ -4 to +23	А
Gate - source surge voltage ($t_{surge} < 300$ ns) $V_{GSS_surge}^{*5}$ -4 to +23	А
Gate - source surge voltage (t _{surge} < 300hs) V _{GSS_surge} -4 to +23	V
Recommended turn-on gate - source drive voltage V _{GS_on} ^{*6} +15 to +18	V
	3 V
Recommended turn-off gate - source drive voltage $V_{GS_{off}}$ 0	V
Virtual junction temperature T _{vj} 175	°C
Range of storage temperatureT-40 to +17	5 °C

Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating

•Electrical characteristics ($T_{vj} = 25^{\circ}C$ unless otherwise specified)

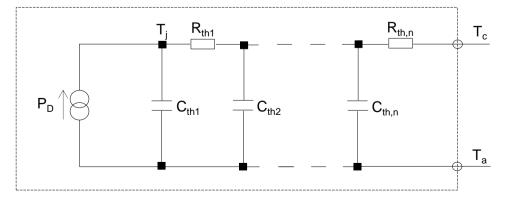
Deremeter	Cumphal	Conditions		L locit			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain - Source breakdown	V	$V_{GS} = 0 V, I_{D} = 5.3 mA$				V	
voltage	V _{(BR)DSS}	T _{vj} = 25°C	750	-	-	V	
		$V_{GS} = 0 V, V_{DS} = 750V$					
Zero Gate voltage Drain current	I_{DSS}	T _{vj} = 25°C	-	1	80	μA	
		T _{vj} = 150°C	-	10	-		
Gate - Source leakage current	I _{GSS+}	$V_{GS} = +21V$, $V_{DS} = 0V$	-	-	100	nA	
Gate - Source leakage current		$V_{GS} = -4V$, $V_{DS} = 0V$	-	-	-100	nA	
Gate threshold voltage	$V_{GS(th)}{}^{*7}$	$V_{DS} = 10V, I_{D} = 8.89mA$	2.8	-	4.8	V	
		$V_{GS} = 18V, I_{D} = 17A$					
Static Drain - Source on - state resistance	R _{DS(on)} *8	T _{vj} = 25°C	-	45	59	mΩ	
		T _{vj} = 150°C	-	77	-		
Gate input resistance	R_G	f = 1MHz, open drain	-	4	-	Ω	

Thermal resistance

Paramotor	Symbol		Values		Unit
Parameter	Symbol	Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	${\sf R_{thJC}}^{*9}$	-	1.2	1.6	K/W

•Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	8.9 ×10 ⁻²		C _{th1}	5.3 ×10 ⁻⁴	
R _{th2}	5.7 ×10 ⁻¹	K/W	C _{th2}	2.8 ×10 ⁻³	Ws/K
R _{th3}	5.3 ×10 ⁻¹		C _{th3}	1.5 ×10 ⁻¹	





•Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

Devenuetor	O week al	rmbol Conditions -		Values			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Transconductance	g _{fs} *8	$V_{DS} = 10V, I_{D} = 17A$	-	9.3	-	S	
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	1460	-		
Output capacitance	C _{oss}	V _{DS} = 500V	-	69	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	5	-		
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V$ to 500V	-	90	-	pF	
Total Gate charge	Q _g *8	V _{DS} = 500V I _D = 17A	-	63	-		
Gate - Source charge	Q _{gs} *8	$V_{GS} = 18V$	-	14	-	nC	
Gate - Drain charge	Q _{gd} *8	See Fig. 1-1, 1-2.	-	19	-		
Turn - on delay time	t _{d(on)} *8	V _{DS} = 500V I _D = 17A	-	5.1	-		
Rise time	t _r *8	V _{GS} = +18V / 0V	-	16	-	ns	
Turn - off delay time	t _{d(off)} *8	$R_G = 3.3\Omega$, L = 250µH E _{on} includes diode	-	27	-	113	
Fall time	t _f *8	reverse recovery $L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF	-	10	-		
Turn - on switching loss	E _{on} *8	See Fig. 2-1, 2-2, 2-3.	-	112	-	μJ	
Turn - off switching loss	E _{off} *8		-	17	-	ро 	
V _{GS(on)} = +15V Short-circuit	- t _{sc} *9	V _{DS} ≤ 400V V _{DS,peak} ≤ 750V	-	12.0	-	μs	
withstand time $V_{GS(on)} = +18V$		$T_{vj(start)} = 25^{\circ}C$ $R_{G} = 2.2\Omega$	-	11.5	-	μs	



•Body diode electrical characteristics (Source-Drain) (T_{vi} = 25°C unless otherwise specified)

Doromotor	Symbol	Conditions	Values			L Incit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage	V_{SD}^{*8}	$V_{GS} = 0V, I_S = 17A$	-	3.3	-	V
Reverse recovery time	t _{rr} *8	$I_F = 17A$ $V_R = 500V$	-	9.3	-	ns
Reverse recovery charge	Q _{rr} *8	di/dt = 2900A/µs	-	89	-	nC
Peak reverse recovery current	I _{rrm} *8	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	19	-	А

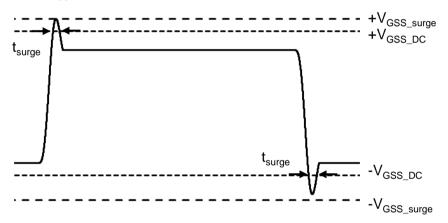
*1 Limited by maximum T_{vj} and for Max. R_{thJC} .

*2 Pulse width and duty cycle are limited by $T_{vj,max}$.

*3 Only for body-diode, Repititive pulse, PW \leq 1.5µs, Duty cycle \leq 5%

*4 When used as a protective function, PW \leq 10µs

*5 Example of acceptable V_{GS} waveform



Please note especially when using driver source that V_{GSS_surge} must be in the range of absolute maximum rating.

- *6 Please be advised not to use SiC-MOSFETs with V_{GS} below 10V as doing so may cause thermal runaway.
- *7 Tested after applying $V_{GS} = 21V$ for 100ms.
- *8 Pulsed
- *9 The value is based on TO-247 package. Single Pulsed.
- *10 Measured conformable to JESD51-14.

See the application note "rthjc_measurement_and_usage_an-e.pdf". Link

URL: https://fscdn.rohm.com/en/products/databook/applinote/discrete/common/rthjc_measurement_and_usage_an-e.pdf





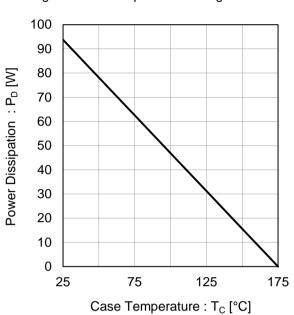


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

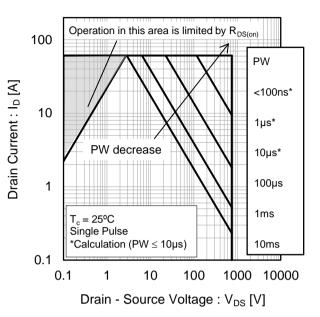
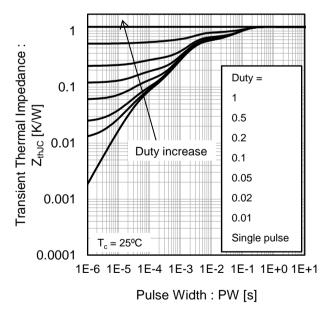
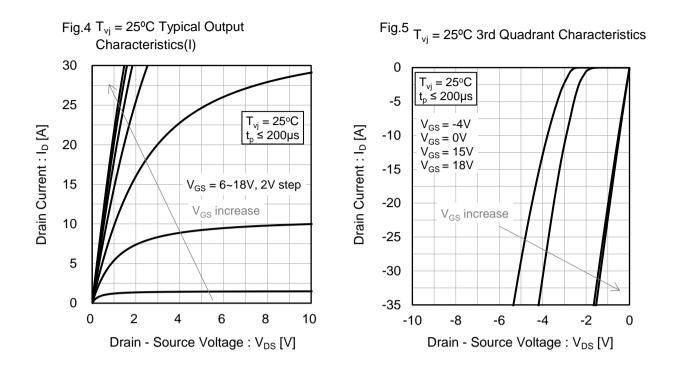


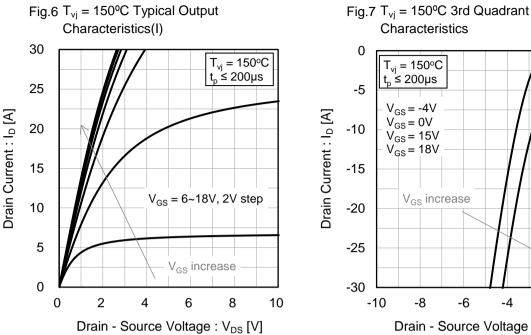
Fig.3 Typical Transient Thermal Impedance vs. Pulse Width

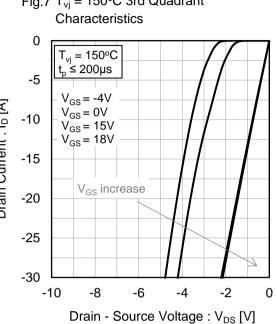


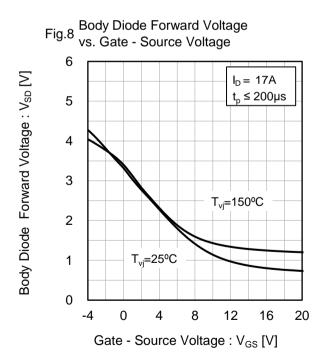














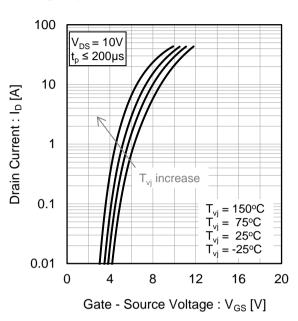
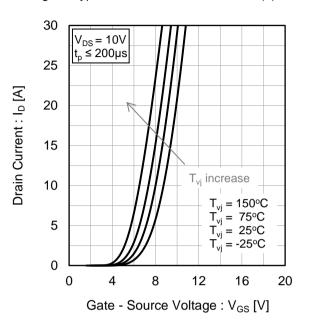


Fig.9 Typical Transfer Characteristics (I)

Fig.10 Typical Transfer Characteristics (II)



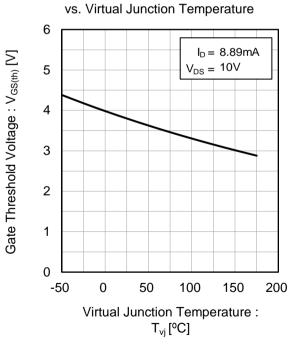


Fig.12 Transconductance vs. Drain Current

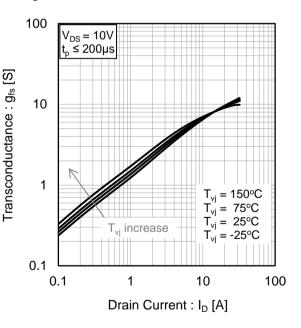
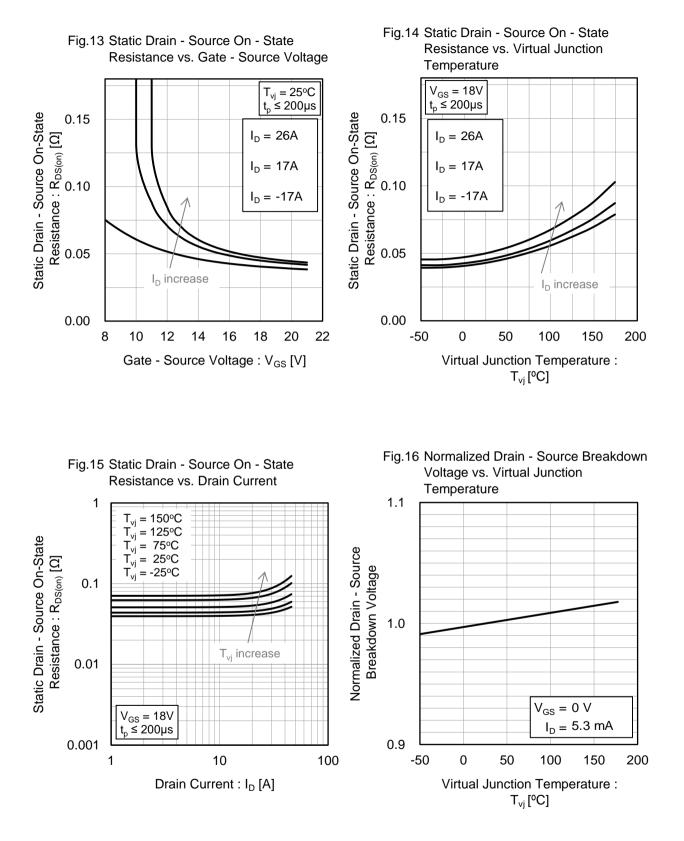


Fig.11 Gate Threshold Voltage











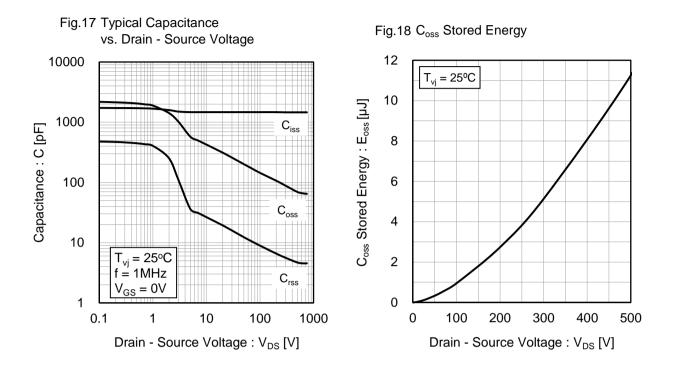
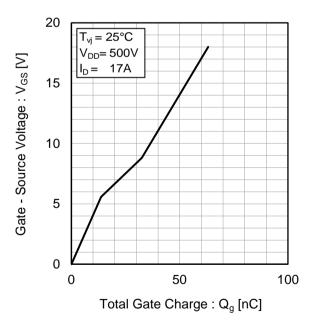
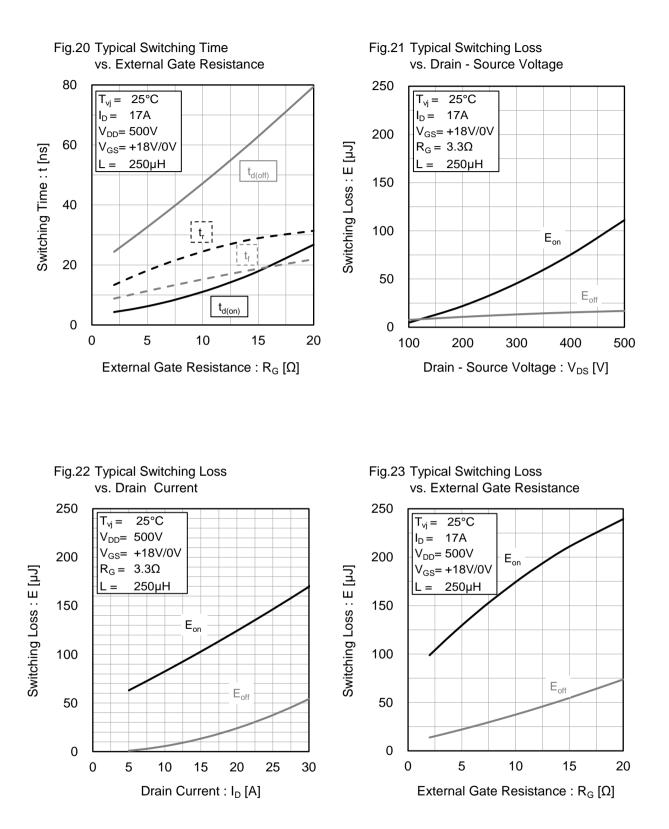


Fig.19 Dynamic Input Characteristics

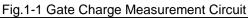








Measurement circuits and waveforms



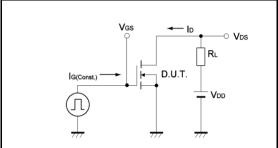


Fig.2-1 Switching Characteristics Measurement Circuit

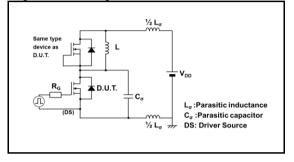


Fig.2-3 Waveforms for Switching Energy Loss

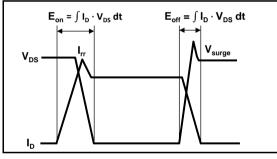


Fig.3-1 Reverse Recovery Time Measurement Circuit

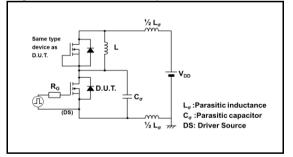


Fig.1-2 Gate Charge Waveform

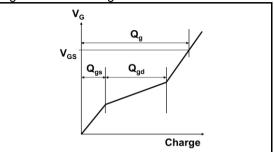


Fig.2-2 Waveforms for Switching Time

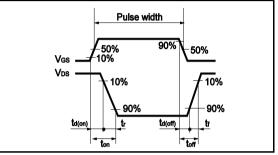
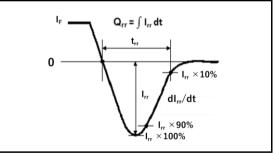
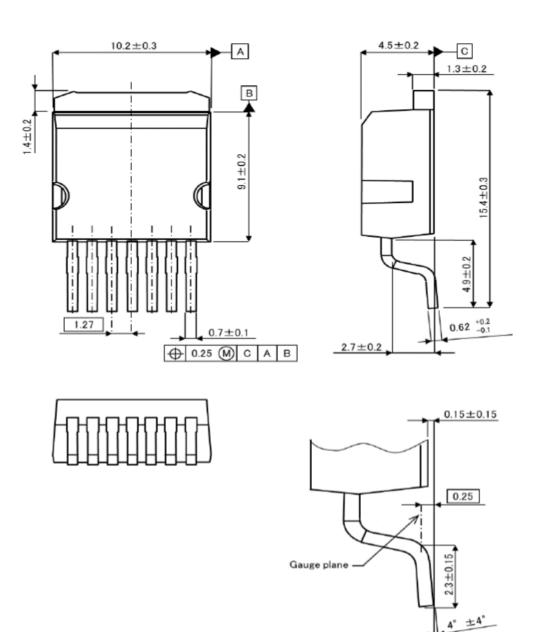


Fig.3-2 Reverse Recovery Waveform



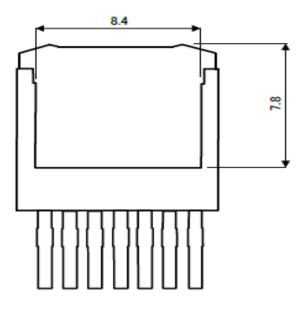


Package Dimensions

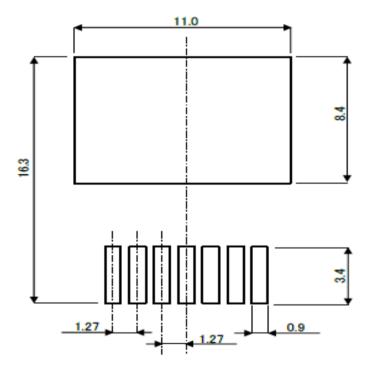


Unit: mm





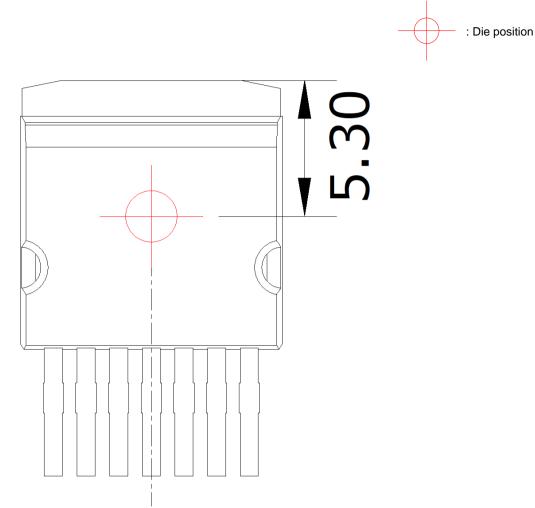
RECOMMENDED FOOTPRINT DIMENSIONS







Die Bonding Layout



•Front view of the packaging.

•Dimensions are design values.

·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm





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